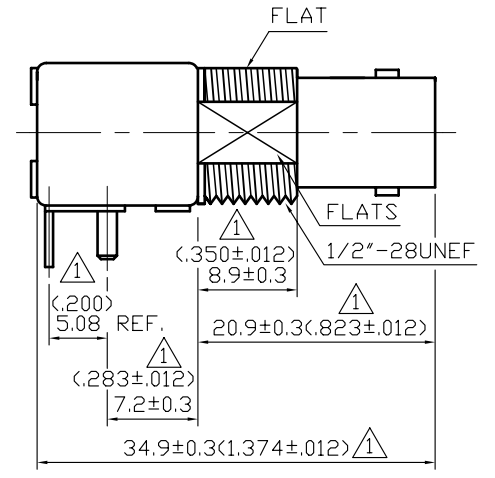
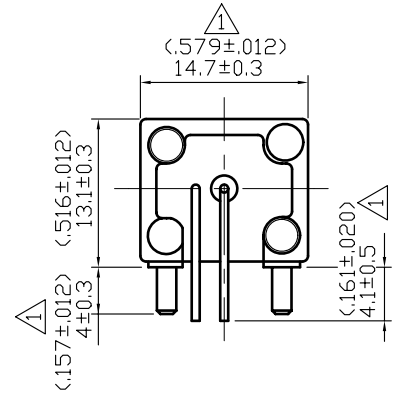
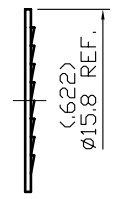
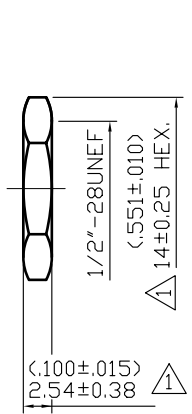


NO	DESCRIPTION	DATE
	14.0 HEX. → 14±0.25 HEX. ; 2.5 → 2.54±0.38 4.0 → 4±0.3 ; 14.7 REF. → 14.7±0.3 20.9 REF. → 20.9±0.3 ; 34.9±0.5 → 34.9±0.3 Ø2.1X2 → Ø2.00X2 ; Ø0.9X2 → Ø0.90X2 ADD 10.16 ; 5.08 REF. ; 7.2±0.3 ; 8.9±0.3 ; 4.1±0.5 DEL 6.9 REF. ; 5.08 12.0 REF. → 11.7 ; Ø12.9 REF. → Ø12.83 IMPEADANCE 50 OHM NOMINAL → NORMAL IMPEDANCE-- 50 OHMS 0-4 GHZ → 0-1 GHZ RATING VOLTAGE 500 VOLTS PEAK → TESTING VOLTAGE-- 500 VOLTS RMS DEL VSWR; CONTACT RESISTANCE INSULATION RESISTANCE:500 MEGA OHMS(MIN) → INSULATION RESISTANCE -- 5000 MEGOHMS MIN. -55° C TO +85° C → -40° C TO +60° C DURABILITY :500 CYCLES → MATING/UNMATING--500 CYCLES ADD MIL-STD-202,METHOD 107,COND.B. ADD MIL-STD-202,METHOD 204,COND.B. MODIFICATION MATERIAL	04.22.09'



SPECIFICATIONS:

MECHANICAL CHARACTERISTICS:

MATING/UNMATING--500 CYCLES Δ

ELECTRICAL CHARACTERISTICS:

NORMAL IMPEDANCE-- 50 OHMS Δ

FREQUENCY RANGE-- 0-1 GHZ Δ

TESTING VOLTAGE-- 500 VOLTS RMS Δ

DIELECTRIC WITHSTANDING VOLTAGE-- 1500 VOLTS RMS

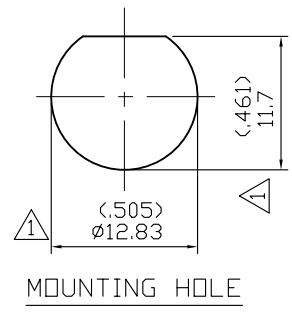
INSULATION RESISTANCE-- 5000 MEGOHMS MIN. Δ

ENVIROMENTAL CHARACTERISTICS:

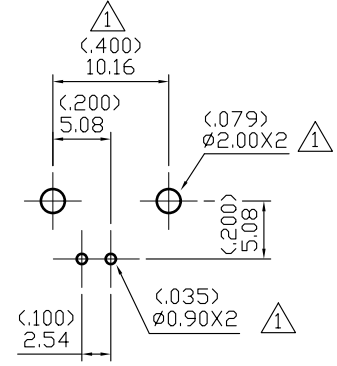
TEMPERATURE RANGE-- -40° C TO +60° C Δ

THERMAL SHOCK-- MIL-STD-202,METHOD 107,COND.B. Δ

PHYSICAL SHOCK-- MIL-STD-202,METHOD 204,COND.B. Δ



MOUNTING HOLE



RECOMMEND PCB LAYOUT



APPROVED

by _____ DATE: _____

NO	DESCRIPTION	MATERIAL	Q' TY	FINISH
7	SOLDER PIN	COPPER WIRE	1	TIN Δ
6	CENTER CONTACT	PHOSPHOROUS BRONZE WITH GOLD PLATING AT CONTACT AREA TIN PLATING AT TAIL	1	GOLD TIN Δ
5	INSULATION	POLYPROPYLENE UL 94HB	1	NONE Δ
4	WASHER	S50C	1	NICKEL Δ
3	NUT	BRASS	1	NICKEL Δ
2	BODY	ZINC ALLOY	1	NICKEL Δ
1	MOUNTING POST	BRASS	2	TIN Δ

DESCRIPTION		BNC RIGHT ANGLE PCB MOUNT JACK RECEPTACLE(METAL HOUSING)							
製圖	DRAWN	TOLERANCE	品名	13-60-6 D.G.Z		日期	DATE	版次	REV.
	CHECK	.X ±0.2	TITLE	\ROHS COMPLIANT <50μ>		08.10.95'		B-1	
檢圖	CHECK	.XX ±0.1	單位	mm(in)		DWG.NO. 13-0318			
	APPROVAL	.XXX ±0.05	比例	SCALE		RS5465165			
認定	ANGLE	±5°							